



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

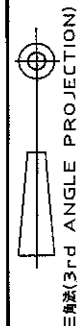
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



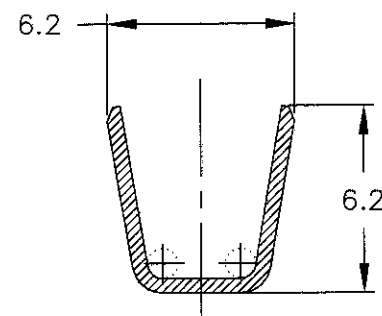
NUMBER 1318696



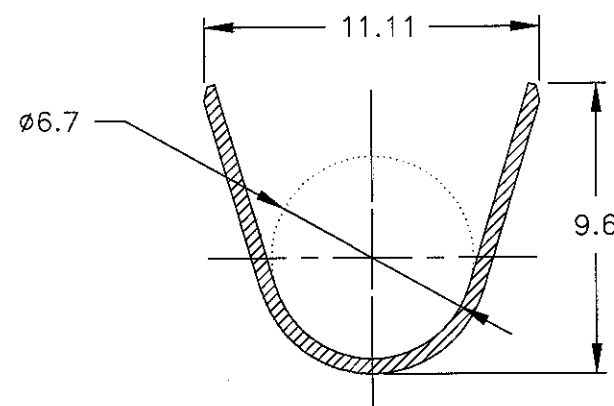
METRIC

単位: 寸法 DIMENSIONS IN MM. DO NOT SCALE PRINT

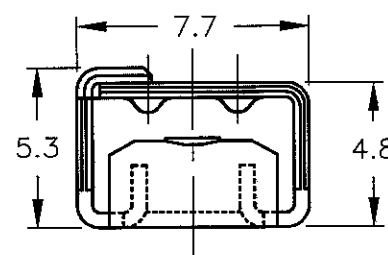
PRINT DIST



断面 "A" - "A"
SECT "A" - "A"

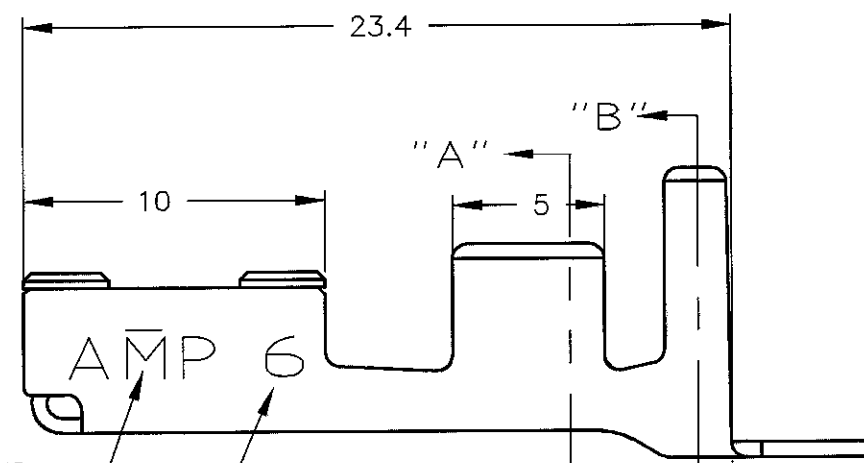
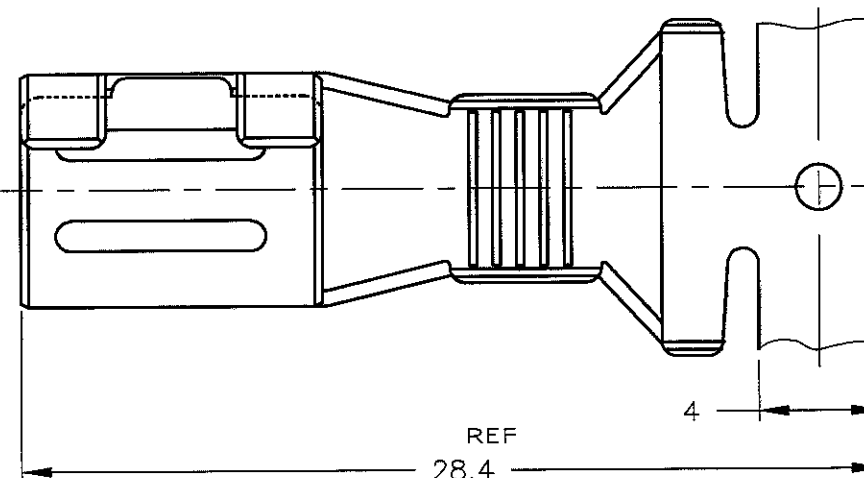
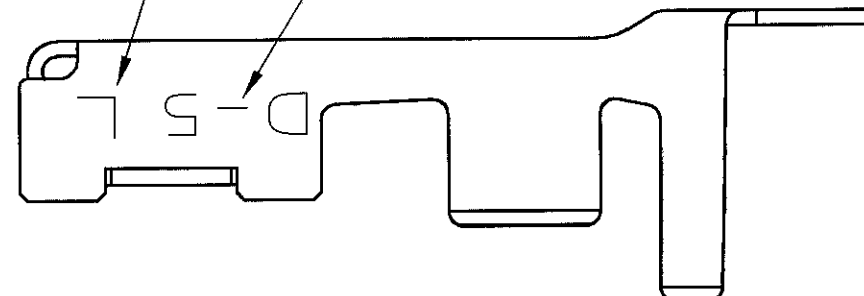


断面 "B" - "B"
SECT "B" - "B"



抱合電線断面積 ID マーク
WIRE RANGE ID MARK

コンタクト ID マーク
CONTACT ID MARK



AMPマーク
AMP MARK

PLATING ID NO
めっき ID No

0.5 MAX
バラ状カット寸法
(L/P CUT)

注記

- ①めっき : コンタクト : 全面Ni下地
Ni下地の上に2.54 μ m MIN銀めっき
- ②めっき : コンタクト : 全面Ni下地
接触部: 0.38 μ m MIN金めっき

製品規格: 108-5453
取付け適用規格: 114-5206

NOTES

- ① FINISH(CONTACT AREA): ALL OVER 2.54 μ m MIN
SILVER PLATING OVER Ni PLATING.
- ② FINISH(CONTACT AREA): 0.38 μ m MIN
GOLD PLATING OVER Ni PLATING.

PRODUCT SPEC. 108-5453
APPLICATION SPEC. 114-5206

2	②	1318697-2	1318696-2
6	①	1318697-6	1318696-6
めっき ID No	仕上(FINISH)	バラ状 L/P	通線状 STRIPPED
PL ID CODE		型番(P/N)	

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抱合電線断面積 (WIRE RANGE) AWG #8				絶縁外径 (INSULATION DIA.) 4.9/7.8 mmφ				名称 (NAME) REC CONTACT "L" SIZE リセ コンタクト "L" サイズ <DYNAMIC D-5 SERIES>			
材料 (MATERIAL) 銅合金 (COPPER ALLOY)				仕上 (FINISH) 表参照 (SEE TABLE)				一般公差 (GENERAL TOLERANCE)			
DR. K.IKEDA 10/FEB/'00				DE. K.IKEDA 10/FEB/'00				10mm ±0.3			
CHK. Y.KATO 10/FEB/'00				APP. I.HASEGAWA 10/FEB/'00				10mm 30mm ±0.35			
LTR 変更 (REVISION RECORD)				DR. CHK DATE				30mm 100mm ±0.4			
								角度 ±3°			
								SIZE LOC 番号 (No.)			
								A3 J 1318696			
								尺度 (SCALE) REV. SHEET			
								4-1 A1 1 OF 1			